

General Description

The CMP100P03B is a P-channel Power MOSFET. They use advanced trench technology to provide excellent $R_{DS(ON)}$.

The device is therefore suitable in advanced high-efficiency switching applications.

Features

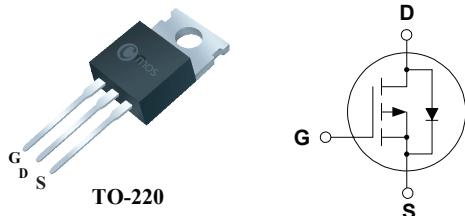
- Fast switching
- Lower On-resistance
- 100% EAS Guaranteed
- Simple Drive Requirement

Product Summary

BVDSS	RDSON	ID
-30V	14mΩ	-80A

Applications

- DC-DC Converters
- Motor control
- LED controller

TO-220 Pin Configuration

Type	Package	Marking
CMP100P03B	TO-220	CMP100P03B

Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	-30	V
V_{GS}	Gate-Source Voltage	± 20	V
$I_D @ T_C = 25^\circ\text{C}$	Continuous Drain Current	-80	A
I_{DM}	Pulsed Drain Current	-240	A
EAS	Single Pulse Avalanche Energy ¹	225	mJ
$P_D @ T_C = 25^\circ\text{C}$	Total Power Dissipation	65	W
T_{STG}	Storage Temperature Range	-55 to 175	$^\circ\text{C}$
T_J	Operating Junction Temperature Range	-55 to 175	$^\circ\text{C}$

Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Junction-to-Ambient	---	62	$^\circ\text{C}/\text{W}$
$R_{\theta JC}$	Junction-to-Case	---	1.1	$^\circ\text{C}/\text{W}$

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$, $I_D=-250\mu\text{A}$	-30	---	---	V
$R_{\text{DS(ON)}}$	Static Drain-Source On-Resistance	$V_{\text{GS}}=-10\text{V}$, $I_D=-30\text{A}$	---	11	14	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$, $I_D=-20\text{A}$	---	15	20	
$V_{\text{GS(th)}}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$, $I_D =-250\mu\text{A}$	-1	---	-3	V
I_{DSS}	Drain-Source Leakage Current	$V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=25^\circ\text{C}$	---	---	-1	uA
		$V_{\text{DS}}=-30\text{V}$, $V_{\text{GS}}=0\text{V}$, $T_J=125^\circ\text{C}$	---	---	-50	
I_{GSS}	Gate-Source Leakage Current	$V_{\text{GS}} = \pm 20\text{V}$, $V_{\text{DS}}=0\text{V}$	---	---	± 100	nA
g_{fs}	Forward Transconductance	$V_{\text{DS}}=-20\text{V}$, $I_D=-11\text{A}$	---	13	---	S
Q_g	Total Gate Charge	$V_{\text{DS}}=-24\text{V}$, $I_D=-50\text{A}$	---	48	---	nC
Q_{gs}	Gate-Source Charge	$V_{\text{GS}}=0$ to -10V	---	7	---	
Q_{gd}	Gate-Drain Charge		---	12	---	
$T_{\text{d(on)}}$	Turn-On Delay Time		---	15	---	ns
T_r	Rise Time	$V_{\text{DD}}=-15\text{V}$, $V_{\text{GS}}=-10\text{V}$, $R_G=3.5\Omega$	---	10	---	
$T_{\text{d(off)}}$	Turn-Off Delay Time	$I_D=-50\text{A}$	---	50	---	
T_f	Fall Time		---	25	---	
C_{iss}	Input Capacitance		---	4000	---	pF
C_{oss}	Output Capacitance	$V_{\text{DS}}=-25\text{V}$, $V_{\text{GS}}=0\text{V}$, $f=1\text{MHz}$	---	800	---	
C_{rss}	Reverse Transfer Capacitance		---	500	---	

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I_s	Continuous Source Current	$V_G=V_D=0\text{V}$, Force Current	---	---	-80	A
I_{SM}	Pulsed Source Current		---	---	-240	A
V_{SD}	Diode Forward Voltage	$V_{\text{GS}}=0\text{V}$, $I_F=-10\text{A}$	---	---	-1.5	V

Notes

1. The test condition is $V_{\text{DD}}=-25\text{V}$, $V_{\text{GS}}=-10\text{V}$, $L=0.5\text{mH}$, $I_{\text{AS}}=-30\text{A}$

This product has been designed and qualified for the consumer market.

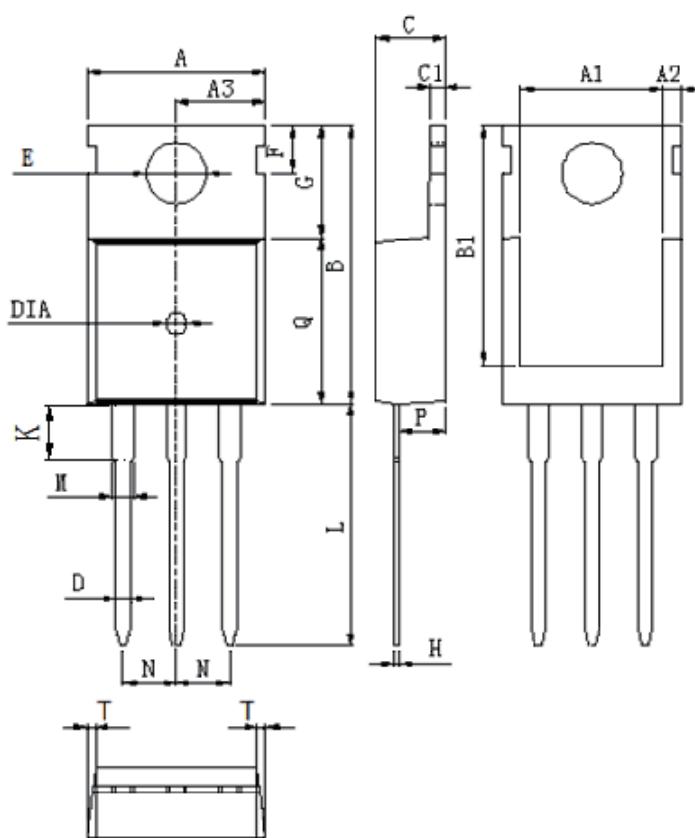
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Cmos reserves the right to improve product design, functions and reliability without notice.

Package Dimensions

P-Channel Enhancement Mode MOSFET

TO-220 Package Outline Drawing



DIM	MILLIMETERS
A	10.0±0.3
A1	8.64±0.2
A2	1.15±0.1
A3	5.0±0.2
B	15.8±0.4
B1	13.2±0.3
C	4.56±0.1
C1	1.3±0.2
D	0.8±0.2
E	3.6±0.2
F	2.95±0.3
G	6.5±0.3
H	0.5±0.1
K	3.1±0.2
L	13.2±0.4
M	1.25±0.1
N	2.54±0.1
P	2.4±0.3
Q	9.0±0.3
T	W:0.35
DIA	◎1.5(deep 0.2)

Unit :mm